

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

- 8-Bit Parallel-Out Storage Register Performs Serial-to-Parallel Conversion with Storage
- Asynchronous Parallel Clear
- Active High Decoder
- Enable/Disable Input Simplified Expansion
- Expandable for N-Bit Applications
- Four District Functional Modes
- Package Options Include Ceramic Chip Carriers and Flat Packages in Addition to Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

These 8-bit addressable latches are designed for general purpose storage applications in digital systems. Specific uses include working registers, serial-holding registers, and active-high decoders or demultiplexers. They are multifunctional devices capable of storing single-line data in eight addressable latches, and being a 1-of-8 decoder or demultiplexer with active-high outputs.

Four distinct modes of operation are selectable by controlling the clear (\overline{CLR}) and enable (\overline{G}) inputs as enumerated in the function table. In the addressable-latch mode, data at the data-in terminal is written into the addressed latch. The addressed latch will follow the data input with all unaddressed latches remaining in their previous states. In the memory mode, all latches remain in their previous states and are unaffected by the data or address inputs. To eliminate the possibility of entering erroneous data in the latches, enable \overline{G} should be held high (inactive) while the address lines are changing. In the 1-of-8 decoding or demultiplexing mode, the addressed output will follow the level of the D input with all other outputs low. In the clear mode, all outputs are low and unaffected by the address and data inputs.

The SN54259 and SN54LS259B are characterized for operation over the full military temperature range of – 55°C to 125°C. The SN74259 and SN74LS259B are characterized for operation from 0°C to 70°C.

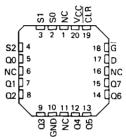
SN54259, SN54LS2598 . . . J OR W PACKAGE SN74259 . . . N PACKAGE SN74LS259B . . . D OR N PACKAGE

(TOP VIEW)



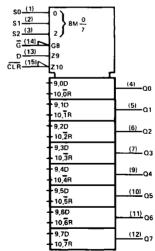
SN54LS259B . . . FK PACKAGE

(TOP VIEW)



NC - No internal connection

logic symbol†



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



2-735

ABLE LATCH SELECTION TABLE

CLR	Ğ	OUTPUT OF ADDRESSED LATCH	EACH OTHER OUTPUT	FUNCTION
Н	L	D	0,0	Addressable Latch
н	н	0,0	Q _{iO}	Memory
L	L	ם	L L	8-Line Demultiplexer
L	н	L	L	Clear

S2	S1	SO	ADDRESSED
L	L	L	0
L	L	н	1
L	н	L	2
L	н	н	3
н	L	Ł	4
н	L	Н	5
н	Н	L	6
			I _

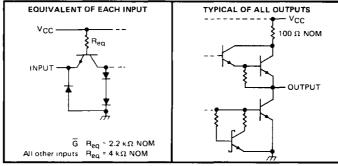
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SELECT INPUTS

- H high level, L = low level
- $D \stackrel{\scriptscriptstyle \perp}{=} \, the$ level at the data input
- Q_{10} = the level of Q_1 (i.e. 0, 1, ..., 7) as appropriate) before the indicated steady-state input conditions were established,

schematic of inputs and outputs .259

'259



LS259B

CLS259B

CLS259B

CLS259B

CLS259B

CLS259B

TYPICAL OF ALL OUTPUTS

VCC

120 Ω NOM

INPUT

INPUT

OUTPUT

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage (see Note 1)	7 V
Input voltage: SN54259, SN74259	5.5 V
SN54LS259B, SN74LS259B	
Operating free-air temperature range: SN54259, SN54LS259B	– 55°C to 125°C
SN74259. SN74LS259B	0°C to 70°C
Storage temperature range	– 65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



TTL Devices

recommended operating conditions

		SN54	259	9 SN74259		
		MIN NO	MIN NOM MAX MIN NO		MAX	UNIT
Supply voltage, VCC		4.5	5 5.5	4.75	5 5.25	V
High-level output current, IOH			-800		-800	μА
Low-level output current, IOL			16		16	mA
Width of clear or enable pulse, ty	v	15		15		ns
S	Data	151		151		
Setup time, t _{su}	Address	51		5↑		ns
Low-level output current, IOL	Data	o†		0↑		
	Address	20†		20↑		ns
Operating free-air temperature, T	Operating free-air temperature, TA		125	0	70	°C

[†]The arrow indicates that the rising edge of the enable pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CO	TEST CONDITIONS [†]		SN54259			SN74259			
	PANAMETEN		1231 00	INDITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIH	High-level input voltage	9			2			2			V	
VIL	Low-level input voltage						0.8			0.8	V	
ViK	Input clamp voltage		V _{CC} = MIN,	I _I = 12 mA			-1.5			-1.5	V	
VOH	High-level output volta	ge	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{IH} = 2 V, t _{OH} = -800 μA	2.4	3.4		2.4	3.4		v	
VOL	Low-level output volta	ge	V _{CC} = MIN, V _{IL} = 0.8 V,	V _{1H} = 2 V, I _{OL} = 16 mA		0.2	0.4		0.2	0.4	v	
11	Input current at maxin	num input voltage	V _{CC} = MAX,	V _I = 5.5 V			1			1	mA	
ΊΗ	High-level input current	G Other inputs	V _{CC} = MAX,	V ₁ = 2.4 V			80 40			80 40	μА	
1 ₁ L	Low-level input current	G Other inputs	V _{CC} = MAX,	V _I = 0.4 V			-3.2 -1.6			-3.2 -1.6	mA	
los	Short-circuit output current§		VCC = MAX		~18		-57	-18		57	mA	
lcc	Supply current		VCC = MAX,	See Note 2		60	90		60	90	mA	

¹ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPHL_	CLR	Any Q	$\Delta \ln y \Omega$		16	25	ns
^t PLH	Data	A = 1. O			14	24	ns
^t PHL	Data	Anyu			11	20	¬ ''`
^t PLH	A -1-1-000	Any		15	28	ns	
tPHL.	Address	Anyu			17	28	7 "
[†] PLH		G Any Q			12	20	ns
tPHL.	G				11	20	7 113

tPLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1



[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time.

NOTE 2 ICC is measured with the inputs grounded and the outputs open.

			SN	154LS2	59B	SN	174LS25	59B	UNIT
			MIN	MOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage					2			V
VIL					0.7			0.8	V
ЮН	High-level output current				- 0.4			- 0.4	mΑ
lOL	Low-level output current				4			8	mΑ
	•	Ğlow	17			17			ns
tw	Pulse duration	CLR low	10			10			115
		Data before G ↑	20			20			
t _{su}	Set up time	Address before G †	17			17			ns
	High-level input voltage Low-level input voltage High-level output current Low-level output current Puise duration	Address before G ↓	0			0			
		Data after G †	0			0			
th	Held time	Address after G ↑	0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54LS259B			SN74LS259B			
	TEST CONDITIONS.	MIN TY	P MAX	MIN	TYP	MAX	UNIT		
ViK	V _{CC} = MIN, I _I = - 18 mA		- 1,5			- 1.5	V		
Voн	V_{CC} = MIN. $V_{IH} \approx 2 V$, V_{IL} = MAX. I_{OH} = -0.4 mA	2.5	3.4	2.7	3.4		٧		
V-:	$V_{CC} = MIN$, $V_{IH} = 2 V$, $I_{OL} = 4 mA$	0	.25 0.4		0.25	0.4	v		
VOL	V _{IL} = MAX				0.35	0,5	ľ		
l _l	VCC = MAX, VI = 7 V		0.1			0.1	mΑ		
ΉΗ	V _{CC} = MAX, V _I = 2.7 V		20			20	μА		
İIL	V _{CC} = MAX, V _I = 0.4 V		- 0.4			- 0.4	mA		
IOS	V _{CC} = MAX	- 20	- 100	- 20		- 100	mΑ		
Icc .	V _{CC} = MAX, See Note 2		27 36		22	36	mA		

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST COM	IDITIONS	MIN	TYP	мах	UNIT
tPHL	CLR	Any Q				12	18	пş
^t PLH	Data	Any Q	C _L = 15 pF, R _L			19	30	ns
^t PHL	Data	Anya		$R_1 = 2 k\Omega$,		13	20	l ''s
^t PLH	Address	Any Q	See Note 3			17	27	ns
₹PHL	Address	Any U	See MO(6.3			14	20] ''`
^t PLH	G	Any Q				15	24	
tPHL	J	, Any d				15	24	ns

tpLH = propagation delay time, low-to-high-level output



 $^{^{\}ddagger}$ All typical values are at V_{CC} = 5 V, T_{A} = 25 °C

s Not more than one output should be shorted at a time, and duration short-circuit should not exceed one second.

NOTE 2 ICC is measured with the inputs grounded and the outputs open.

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.